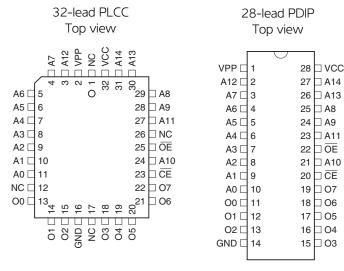


## 2. Pin configurations

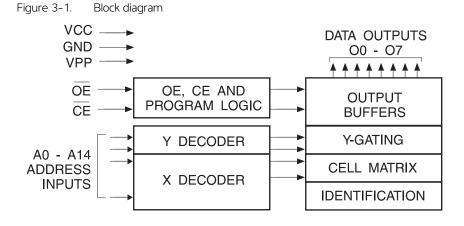
| Pin name | Function      |
|----------|---------------|
| A0 - A14 | Addresses     |
| 00 - 07  | Outputs       |
| CE       | Chip enable   |
| ŌĒ       | Output enable |
| NC       | No connect    |
|          |               |



Note: PLCC package pins 1 and 17 are "don't connect"

## 3. System considerations

Switching between active and standby conditions via the chip enable pin may produce transient voltage excursions. Unless accommodated by the system design, these transients may exceed datasheet limits, resulting in device non-conformance. At a minimum, a  $0.1\mu$ F, high-frequency, low inherent inductance, ceramic capacitor should be utilized for each device. This capacitor should be connected between the V<sub>CC</sub> and ground terminals of the device, as close to the device as possible. Additionally, to stabilize the supply voltage level on printed circuit boards with large EPROM arrays, a  $4.7\mu$ F bulk electrolytic capacitor should be utilized, again connected between the V<sub>CC</sub> and ground terminals. This capacitor should be positioned as close as possible to the point where the power supply is connected to the array.



## 2 Atmel AT27C256R

## 4. Absolute maximum ratings\*

| Noto: 1 Minimum voltago is 0.6V/DC which may under                                 |
|--|
| V <sub>PP</sub> supply voltage with respect to ground2.0V to +14.0V <sup>(1)</sup> |
| Voltage on A9 with respect to ground2.0V to +14.0V <sup>(1)</sup>                  |
| Voltage on any pin with respect to ground2.0V to +7.0V <sup>(1)</sup>              |
| Storage temperature65°C to +150°C  |
| Temperature under bias55°C to +125°C   |

\*NOTICE: Stresses beyond those listed under "Absolute maximum ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note: 1. Minimum voltage is -0.6V DC, which may undershoot to -2.0V for pulses of less than 20ns. Maximum output pin voltage is  $V_{CC}$  + 0.75V DC, which may overshoot to +7.0V for pulses of less than 20ns.

## 5. DC and AC characteristics

| Mode/Pin                              | CE               | ŌĒ               | Ai  | V <sub>PP</sub> | Outputs             |
|---------------------------------------|------------------|------------------|---|-----------------|---------------------|
| Read                                  | V <sub>IL</sub>  | V <sub>IL</sub>  | Ai  | V <sub>CC</sub> | D <sub>OUT</sub>    |
| Output disable                        | V <sub>IL</sub>  | V <sub>IH</sub>  | X <sup>(1)</sup>  | V <sub>CC</sub> | High Z              |
| Standby                               | V <sub>IH</sub>  | X <sup>(1)</sup> | X <sup>(1)</sup>  | V <sub>CC</sub> | High Z              |
| Rapid program <sup>(2)</sup>          | V <sub>IL</sub>  | V <sub>IH</sub>  | Ai  | V <sub>PP</sub> | D <sub>IN</sub>     |
| PGM verify <sup>(2)</sup>             | X <sup>(1)</sup> | V <sub>IL</sub>  | Ai  | V <sub>PP</sub> | D <sub>OUT</sub>    |
| Optional PGM verify <sup>(2)</sup>    | V <sub>IL</sub>  | V <sub>IL</sub>  | Ai  | V <sub>CC</sub> | D <sub>OUT</sub>    |
| PGM inhibit <sup>(2)</sup>            | V <sub>IH</sub>  | V <sub>IH</sub>  | X <sup>(1)</sup>  | V <sub>PP</sub> | High Z              |
| Product identification <sup>(4)</sup> | V <sub>IL</sub>  | V <sub>IL</sub>  | $A9 = V_{H}^{(3)}$ $A0 = V_{IH} \text{ or } V_{IL}$ $A1 - A14 = V_{IL}$ | V <sub>cc</sub> | Identification code |

Table 5-1.Operating Modes

Notes: 1. X can be  $V_{IL}$  or  $V_{IH}$ .

2. Refer to programming characteristics.

3.  $V_{\rm H} = 12.0 \pm 0.5 V.$ 

4. Two identifier bytes may be selected. All Ai inputs are held low  $(V_{IL})$ , except A9, which is set to  $V_{H}$ , and A0, which is toggled low  $(V_{IL})$  to select the manufacturer's identification byte and high  $(V_{IH})$  to select the device code byte.

| Table 5-2. | DC and AC operating conditions for | or read operation |
|------------|------------------------------------|-------------------|
|            |                                    |                   |

|                        |          | Atmel A      | T27C256R      |
|------------------------|----------|--------------|---------------|
|                        |          | -45          | -70           |
| Operating temp. (case) | Ind.     | -40°C - 85°C | -40°C - 85°C  |
|                        | Auto.    |              | -40°C - 125°C |
| V <sub>CC</sub> supply | c supply |              | 5V ± 10%      |





| Symbol               | Parameter  | Condition   |                         | Min  | Max                   | Units |
|----------------------|--|---|-------------------------|------|-----------------------|-------|
| I                    |  |   | Ind.                    |      | ±1                    | μA    |
| ILI                  | Input load current $V_{IN} = 0$ Output leakage current $V_{OUT} =$ $V_{PP}^{(1)}$ read/standby current $V_{PP} = N$ $V_{CC}^{(1)}$ standby current $I_{SB1}$ (C $V_{CC}^{(1)}$ standby current $I_{SB2}$ (T $V_{CC}$ active current $f = 5M$ Input low voltageInput high voltage | $V_{IN} = 0V$ to $V_{CC}$                                 | Auto.                   |      | ±5                    | μΑ    |
|                      |  |   |                         |      | ±5                    | μΑ    |
| ILO                  | Output leakage current   | $V_{OUT} = 0V \text{ to } V_{CC}$                         | Auto.                   |      | ±10                   | μΑ    |
| l <sub>PP1</sub> (2) | V <sub>PP</sub> <sup>(1)</sup> read/standby current  | V <sub>PP</sub> = V <sub>CC</sub>                         |                         |      | 10                    | μΑ    |
|                      |  | $I_{SB1}$ (CMOS), $\overline{CE} = V_{CC} \pm 0.3V$       |                         |      | 100                   | μΑ    |
| I <sub>SB</sub>      | V <sub>CC</sub> <sup>CC</sup> standby current  | $I_{SB2}$ (TTL), $\overline{CE}$ = 2.0 to $V_{CC}$ + 0.5V |                         |      | 1                     | mA    |
| I <sub>CC</sub>      | V <sub>CC</sub> active current   | $f = 5MHz, I_{OUT} = 0mA,$                                | $\overline{E} = V_{IL}$ |      | 20                    | mA    |
| V <sub>IL</sub>      | Input low voltage  |   |                         | -0.6 | 0.8                   | V     |
| V <sub>IH</sub>      | Input high voltage   |   |                         | 2.0  | V <sub>CC</sub> + 0.5 | V     |
| V <sub>OL</sub>      | Output low voltage   | I <sub>OL</sub> = 2.1mA                                   |                         |      | 0.4                   | V     |
| V <sub>OH</sub>      | Output high voltage  | Ι <sub>ΟΗ</sub> = -400μΑ                                  |                         | 2.4  |                       | V     |

Table 5-3. DC and operating characteristics for read operation

Notes: 1.  $V_{CC}$  must be applied simultaneously with or before  $V_{PP}$ , and removed simultaneously with or after  $V_{PP}$ .

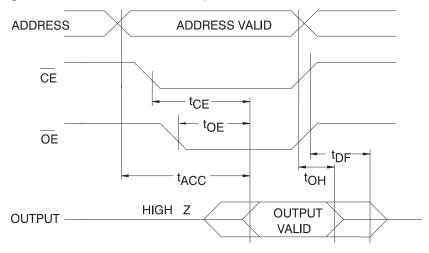
2.  $V_{PP}$  may be connected directly to  $V_{CC}$ , except during programming. The supply current would then be the sum of  $I_{CC}$  and  $I_{PP}$ .

Table 5-4. AC characteristics for read operation

|                                 |   |  |     | Atmel AT27C256R |     |     |       |
|---------------------------------|---|--|-----|-----------------|-----|-----|-------|
|                                 |   |  | -   | 45              | -   | -70 |       |
| Symbol                          | Parameter   | Condition                                | Min | Max             | Min | Max | Units |
| t <sub>ACC</sub> <sup>(1)</sup> | Address to output delay   | $\overline{CE} = \overline{OE} = V_{IL}$ |     | 45              |     | 70  | ns    |
| t <sub>CE</sub> <sup>(1)</sup>  | CE to output delay  | $\overline{OE} = V_{IL}$                 |     | 45              |     | 70  | ns    |
| t <sub>OE</sub> <sup>(1)</sup>  | OE to output delay  | $\overline{CE} = V_{IL}$                 |     | 20              |     | 30  | ns    |
| t <sub>DF</sub> <sup>(1)</sup>  | $\overline{\text{OE}}$ or $\overline{\text{CE}}$ high to output float, whichever occurred first |  |     | 20              |     | 25  | ns    |
| t <sub>OH</sub>                 | Output hold from address, CE or OE, first   | 7  |     | 7               |     | ns  |       |

Note: 1. See AC waveforms for read operation.

Figure 5-1. AC waveforms for read operation<sup>(1)</sup>



- Notes: 1. Timing measurement reference level is 1.5V for -45 devices. Input AC drive levels are  $V_{IL} = 0.0V$  and  $V_{IH} = 3.0V$ . Timing measurement reference levels for all other speed grades are  $V_{OL} = 0.8V$  and  $V_{OH} = 2.0V$ . Input AC drive levels are  $V_{IL} = 0.45V$  and  $V_{IH} = 2.4V$ .
  - 2.  $\overline{OE}$  may be delayed up to  $t_{CE}$   $t_{OE}$  after the falling edge of  $\overline{CE}$  without impact on  $t_{CE}$ .
  - 3.  $\overline{\text{OE}}$  may be delayed up to  $t_{ACC}$   $t_{OE}$  after the address is valid without impact on  $t_{ACC}$ .
  - 4. This parameter is only sampled, and is not 100% tested.
  - 5. Output float is defined as the point when data is no longer driven.

Figure 5-2. Input test waveforms and measurement levels

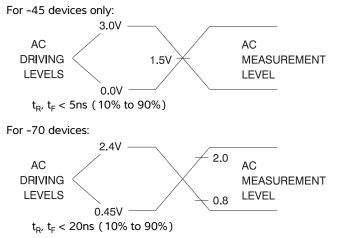






Figure 5-3. Output test load 1.3V (1N914) 3.3K OUTPUT PIN CL

Note: 1.  $C_L = 100 pF$  including jig capacitance, except for the -45 devices, where  $C_L = 30 pF$ .

Table 5-5. Pin capacitance f = 1MHz,  $T = 25^{\circ}C^{(1)}$ 

| Symbol           | Тур | Мах | Units | Conditions     |
|------------------|-----|-----|-------|----------------|
| C <sub>IN</sub>  | 4   | 6   | pF    | $V_{IN} = OV$  |
| C <sub>OUT</sub> | 8   | 12  | pF    | $V_{OUT} = 0V$ |

Note: 1. Typical values for nominal supply voltage. This parameter is only sampled, and is not 100% tested.

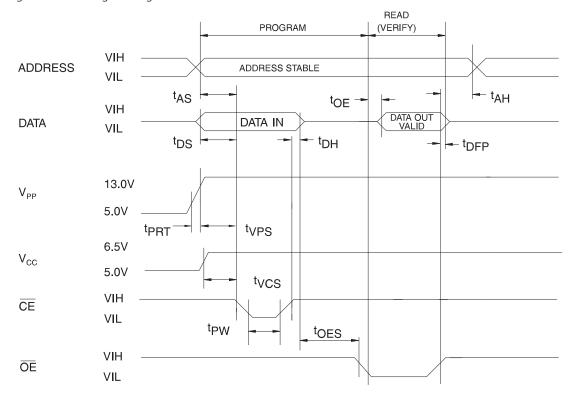


Figure 5-4. Programming Waveforms<sup>(1)</sup>

Notes:

1. The input timing reference is 0.8V for  $V_{\rm IL}$  and 2.0V for  $V_{\rm IH}$ 

- 2.  $t_{OE}$  and  $t_{DFP}$  are characteristics of the device, but must be accommodated by the programmer.
- 3. When programming the Atmel AT27C256R, a 0.1µF capacitor is required across V<sub>PP</sub> and ground to suppress spurious voltage transients.

## 6 Atmel AT27C256R

Table 5-6. DC programming characteristics  $T_{A} = 25 \pm 5^{\circ}\text{C}, \, V_{CC} = 6.5 \pm 0.25 \text{V}, \, V_{PP} = 13.0 \pm 0.25 \text{V}$ 

|                  |   |                           | Lin  | nits                |       |
|------------------|---|---------------------------|------|---------------------|-------|
| Symbol           | Parameter   | Test Conditions           | Min  | Max                 | Units |
| I <sub>LI</sub>  | Input load current                                  | $V_{IN} = V_{IL}, V_{IH}$ |      | ±10                 | μA    |
| V <sub>IL</sub>  | Input low level                                     |                           | -0.6 | 0.8                 | V     |
| V <sub>IH</sub>  | Input high level                                    |                           | 2.0  | V <sub>CC</sub> + 1 | V     |
| V <sub>OL</sub>  | Output low volt                                     | I <sub>OL</sub> = 2.1mA   |      | 0.4                 | V     |
| V <sub>OH</sub>  | Output high volt                                    | I <sub>OH</sub> = -400μA  | 2.4  |                     | V     |
| I <sub>CC2</sub> | V <sub>CC</sub> supply current (program and verify) |                           |      | 25                  | mA    |
| I <sub>PP2</sub> | V <sub>pp</sub> current                             | $\overline{CE} = V_{IL}$  |      | 25                  | mA    |
| V <sub>ID</sub>  | A9 product identification voltage                   |                           | 11.5 | 12.5                | V     |

Table 5-7. AC programming characteristics

### $\rm T_{A} = 25 \pm 5^{\circ}C, \, V_{CC} = 6.5 \pm 0.25V, \, V_{PP} = 13.0 \pm 0.25V$

|                  |  |                                     | Lin |     |       |
|------------------|--|-------------------------------------|-----|-----|-------|
| Symbol           | Parameter  | Test conditions <sup>(1)</sup>      | Min | Max | Units |
| t <sub>AS</sub>  | Address setup time   |                                     | 2   |     | μs    |
| t <sub>OES</sub> | OE setup time  | Input rise and fall times           | 2   |     | μs    |
| t <sub>DS</sub>  | Data setup time  | (10% to 90%) 20ns                   | 2   |     | μs    |
| t <sub>AH</sub>  | Address hold time  |                                     | 0   |     | μs    |
| t <sub>DH</sub>  | Data hold time   | Input pulse levels<br>0.45V to 2.4V | 2   |     | μs    |
| t <sub>DFP</sub> | $\overline{\text{OE}}$ high to output float delay <sup>(2)</sup> |                                     | 0   | 130 | ns    |
| t <sub>VPS</sub> | V <sub>PP</sub> setup time                                       | Input timing reference level        | 2   |     | μs    |
| t <sub>VCS</sub> | V <sub>CC</sub> setup time                                       | 0.8V to 2.0V                        | 2   |     | μs    |
| t <sub>PW</sub>  | CE program pulse width <sup>(3)</sup>                            | Output timing reference level       | 95  | 105 | μs    |
| t <sub>OE</sub>  | Data valid from $\overline{OE}^{(2)}$                            | 0.8V to 2.0V                        |     | 150 | ns    |
| t <sub>PRT</sub> | $V_{PP}$ pulse rise time during programming                      |                                     | 50  |     | ns    |

Notes: 1.  $V_{CC}$  must be applied simultaneously with or before  $V_{PP}$  and removed simultaneously with or after  $V_{PP}$ .

2. This parameter is only sampled, and is not 100% tested. Output float is defined as the point where data is no longer driven. See timing diagram.

3. Program pulse width tolerance is  $100\mu s \pm 5\%$ .

| Table 5-8. | The Atmel AT27C256R integrated product identification code |
|------------|--|
|------------|--|

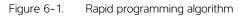
|              |    | Pins |    |    |    |    |    | Hex |    |      |
|--------------|----|------|----|----|----|----|----|-----|----|------|
| Codes        | A0 | 07   | O6 | O5 | 04 | O3 | 02 | 01  | 00 | data |
| Manufacturer | 0  | 0    | 0  | 0  | 1  | 1  | 1  | 1   | 0  | 1E   |
| Device type  | 1  | 1    | 0  | 0  | 0  | 1  | 1  | 0   | 0  | 8C   |

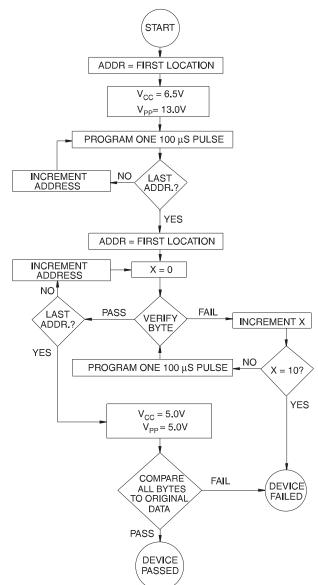


| Π | EL |
|---|----|
|   |    |

## 6. Rapid programming algorithm

A 100 $\mu$ s  $\overline{CE}$  pulse width is used to program. The address is set to the first location. V<sub>CC</sub> is raised to 6.5V and V<sub>PP</sub> is raised to 13.0V. Each address is first programmed with one 100 $\mu$ s  $\overline{CE}$  pulse without verification. Then a verification/reprogramming loop is executed for each address. In the event a byte fails to pass verification, up to 10 successive 100 $\mu$ s pulses are applied with a verification after each pulse. If the byte fails to verify after 10 pulses have been applied, the part is considered failed. After the byte verifies properly, the next address is selected until all have been checked. V<sub>PP</sub> is then lowered to 5.0V and V<sub>CC</sub> to 5.0V. All bytes are read again and compared with the original data to determine if the device passes or fails.





# 7. Ordering information

| t <sub>ACC</sub> I <sub>CC</sub> (mA) |        |                |                     |           |                 |                 |
|---------------------------------------|--------|----------------|---------------------|-----------|-----------------|-----------------|
| (ns)                                  | Active | Standby        | Atmel ordering code | Package   | Lead finish     | Operation range |
| 45                                    | 45 20  | 0.1            | AT27C256R-45JU      | 32J       | Matte tin       | Industrial      |
| 45 20                                 | 0.1    | AT27C256R-45PU | 28P6                | Matte tin | (-40°C to 85°C) |                 |
| 70 20                                 | 0.1    | AT27C256R-70JU | 32J                 | Matte tin | Industrial      |                 |
|                                       | 20     | 0.1            | AT27C256R-70PU      | 28P6      | Matte tin       | (-40°C to 85°C) |

# Green package (Pb/halide-free)

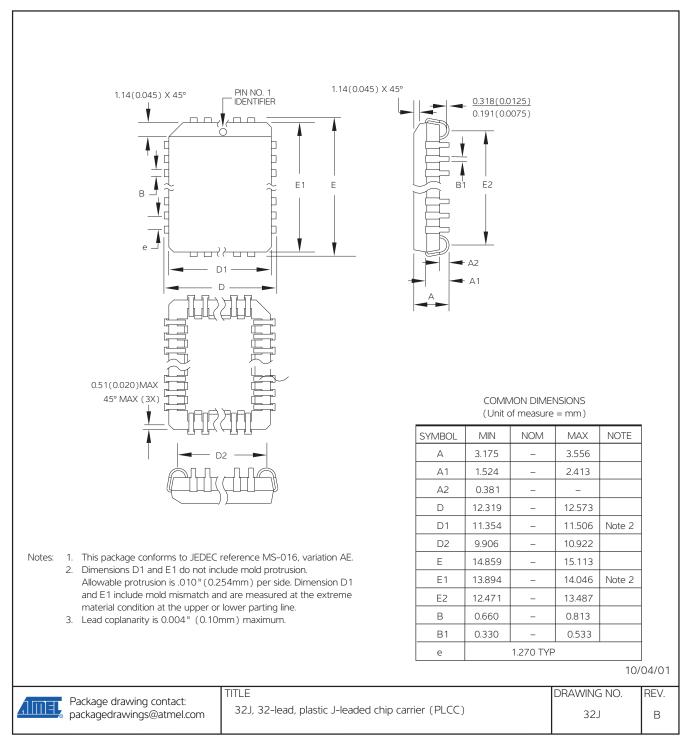
| Package type |   |  |
|--------------|---|--|
| 32J          | 32-lead, plastic, J-leaded chip carrier (PLCC)            |  |
| 28P6         | 28-lead, 0.600" wide, plastic, dual inline package (PDIP) |  |



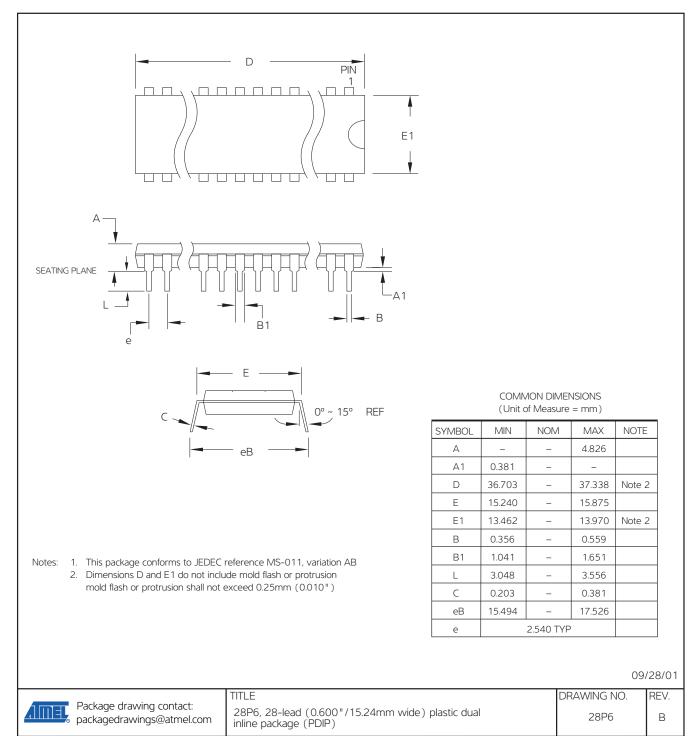


## 8. Packaging information

## 32J – PLCC



### 28P6 - PDIP





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# 9. Revision history

| Doc. rev. | Date    | Comments   |
|-----------|---------|--|
| 00140     | 10/2011 | Correct pinouts  |
| 0014N     | 04/2011 | Remove TSOP and SOIC packages<br>Add lead finish to ordering information |
| 0014M     | 12/2007 |  |



#### Atmel Corporation

2325 Orchard Parkway San Jose, CA 95131 USA Tel: (+1) (408) 441-0311 Fax: (+1) (408) 487-2600 www.atmel.com Atmel Asia Limited Unit 01-5 & 16, 19F BEA Tower, Millennium City 5 418 Kwun Tong Road Kwun Tong, Kowloon HONG KONG Tel: (+852) 2245-6100 Fax: (+852) 2722-1369

#### Atmel Munich GmbH

Business Campus Parkring 4 D-85748 Garching b. Munich GERMANY Tel: (+49) 89-31970-0 Fax: (+49) 89-3194621

#### Atmel Japan

9F, Tonetsu Shinkawa Bldg. 1-24-8 Shinkawa Chuo-ku, Tokyo 104-0033 JAPAN **Tel:** (+81) (3) 3523-3551 **Fax:** (+81) (3) 3523-7581

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